

DATA SHEET

TDA3674

Low dropout voltage/quiescent
current 5 V voltage regulator with
enable

Preliminary specification
Supersedes data of 2000 Feb 01
File under Integrated Circuits, IC01

2001 Jan 24

Low dropout voltage/quiescent current 5 V voltage regulator with enable

TDA3674

FEATURES

- Fixed 5 V, 100 mA regulator with enable function
- Supply voltage range up to 45 V
- Very low quiescent current of 15 μ A (typical value)
- Very low dropout voltage
- High ripple rejection
- Very high stability:
 - Electrolytic capacitors: Equivalent Series Resistance (ESR) < 22 Ω at worst-case condition
 - Other capacitors: 100 nF at $200 \mu\text{A} \leq I_{\text{REG}} \leq 100 \text{ mA}$.
- Pin compatible family TDA3672 to TDA3676
- Protections:
 - Reverse polarity safe (down to -25 V without high reverse current)
 - Negative transient of 50 V ($R_S = 10 \Omega$, $t < 100 \text{ ms}$)
 - Able to withstand voltages up to 18 V at the output (supply line may be short-circuited)
 - ESD protection on all pins
 - DC short-circuit safe to ground and V_P of the regulator output
 - Temperature protection (at $T_j > 150 \text{ }^\circ\text{C}$).

GENERAL DESCRIPTION

The TDA3674 is a fixed 5 V voltage regulator with very low dropout voltage and quiescent current, which operates over a wide supply voltage range.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
V_P	supply voltage	regulator on	3	14.4	45	V
I_q	quiescent supply current	$V_P = 14.4 \text{ V}$; $I_{\text{REG}} = 0 \text{ mA}$; $V_{\text{I(EN)}} = 5 \text{ V}$	–	15	30	μA
Voltage regulator						
V_{REG}	regulator output voltage	$8 \text{ V} \leq V_P \leq 22 \text{ V}$; $I_{\text{REG}} = 0.5 \text{ mA}$	4.8	5.0	5.2	V
		$6 \text{ V} \leq V_P \leq 45 \text{ V}$; $I_{\text{REG}} = 0.5 \text{ mA}$	4.75	5.0	5.25	V
		$0.5 \text{ mA} \leq I_{\text{REG}} \leq 100 \text{ mA}$; $V_P = 14.4 \text{ V}$	4.75	5.0	5.25	V
$V_{\text{REG(drop)}}$	dropout voltage	$V_P = 4.5 \text{ V}$; $I_{\text{REG}} = 50 \text{ mA}$; $T_{\text{amb}} \leq 85 \text{ }^\circ\text{C}$	–	0.18	0.3	V

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
TDA3674AT	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1

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BLOCK DIAGRAM

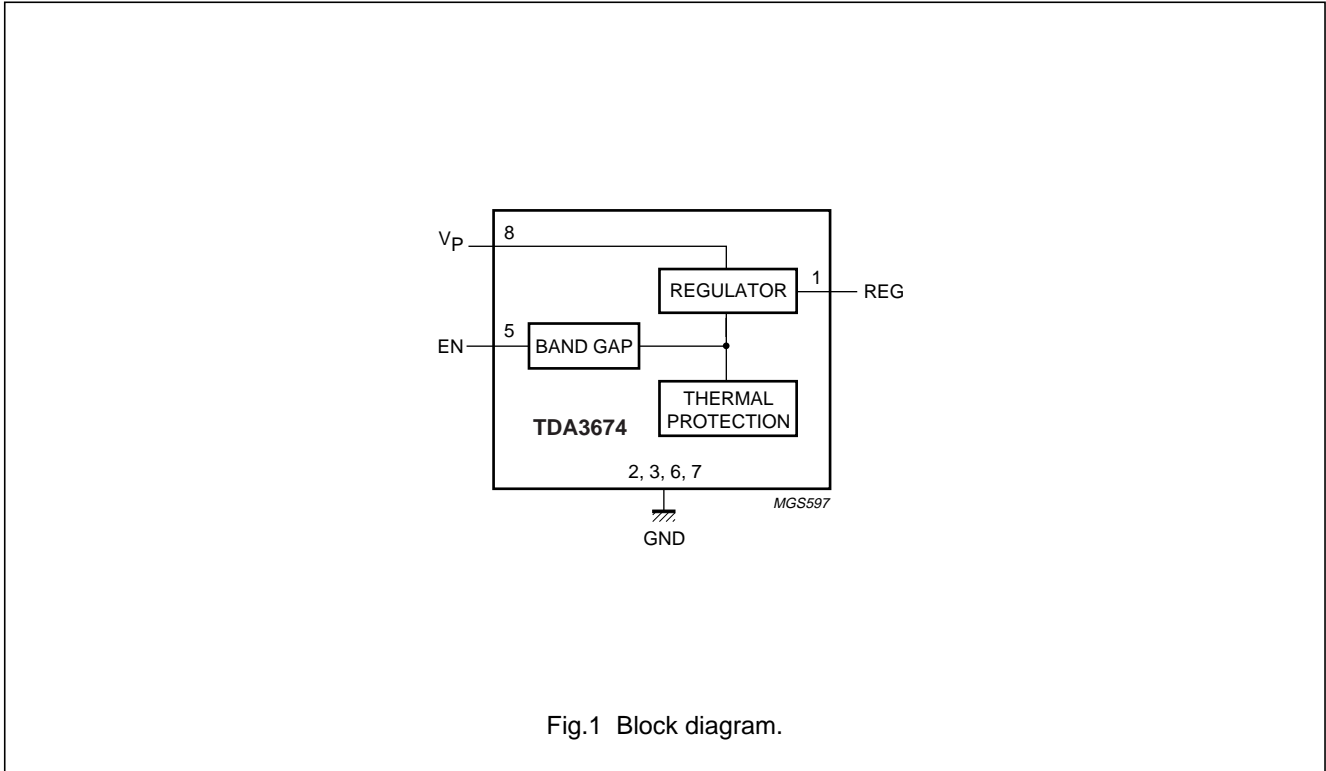


Fig.1 Block diagram.

PINNING

SYMBOL	PIN (SO8)	DESCRIPTION
REG	1	regulator output
GND	2, 3, 6 and 7	ground; note 1
n.c.	4	not connected
EN	5	enable input
VP	8	supply voltage

Note

- All GND pins are connected to the lead frame and can also be used to reduce the total thermal resistance $R_{th(j-a)}$ by soldering these pins to a ground plane. The ground plane on the top side of the PCB acts like a heat spreader.

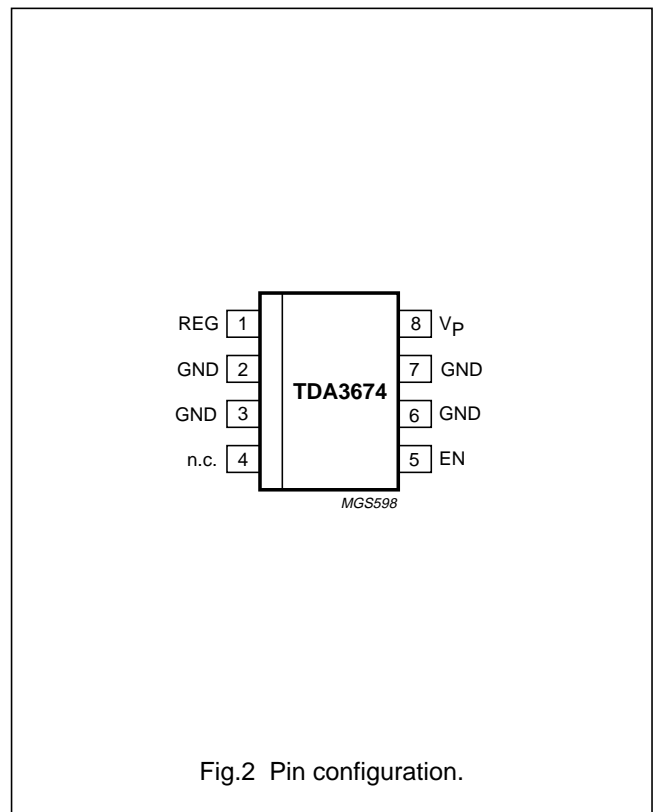


Fig.2 Pin configuration.

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FUNCTIONAL DESCRIPTION

The TDA3674 is a fixed 5 V regulator which can deliver output currents up to 100 mA. The regulator is available in an SO8 package with fused centre pins connected to the lead frame. The regulator is intended for portable, mains, telephone and automotive applications. To increase the lifetime of batteries, a specially built-in clamp circuit keeps the quiescent current of this regulator very low, also in dropout and full load conditions.

The regulator remains operating down to very low supply voltages and below it switches off.

A temperature protection circuit is included, which switches off the regulator output at a junction temperatures above 150 °C.

A new output circuit guarantees the stability of the regulator for a capacitor output circuit with an ESR (worst-case) up to 22 Ω, see Figs 4 and 5. If only a 100 nF capacitor is used, the regulator is fully stable when $I_{REG} > 200 \mu\text{A}$. This is very attractive as the ESR of an electrolytic capacitor increases strongly at low temperatures (no expensive tantalum capacitor is required).

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_P	supply voltage		–	45	V
$V_{P(rp)}$	reverse polarity supply voltage	non-operating	–	–25	V
P_{tot}	total power dissipation	temperature of copper area is 25 °C	–	4.1	W
T_{stg}	storage temperature	non-operating	–55	+150	°C
T_{amb}	ambient temperature	operating	–40	+125	°C
T_j	junction temperature	operating	–40	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; soldered	125	K/W
$R_{th(j-c)}$	thermal resistance from junction to case	to centre pins; soldered	30	K/W

QUALITY SPECIFICATION

In accordance with "SNW-FQ-611E".

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CHARACTERISTICS

$V_P = 14.4\text{ V}$; $T_{\text{amb}} = 25\text{ °C}$; measured in test circuit of Fig.3; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply voltage: pin V_P						
V_P	supply voltage	regulator operating; note 1	3	14.4	45	V
I_q	quiescent current	$V_P = 14.4\text{ V}$; $I_{\text{REG}} = 0\text{ mA}$; $V_{\text{I(EN)}} = 0\text{ V}$	–	4	15	μA
		$V_P = 14.4\text{ V}$; $I_{\text{REG}} = 0\text{ mA}$; $V_{\text{I(EN)}} = 5\text{ V}$	–	15	30	μA
		$6\text{ V} \leq V_P \leq 22\text{ V}$; $I_{\text{REG}} = 10\text{ mA}$	–	0.2	0.5	mA
		$6\text{ V} \leq V_P \leq 22\text{ V}$; $I_{\text{REG}} = 50\text{ mA}$	–	1.4	2.5	mA
Enable input: pin EN						
$V_{\text{I(EN)}}$	enable input voltage	enable off; $V_{\text{REG}} \leq 0.8\text{ V}$	–1	–	+1.0	V
		enable on; $V_{\text{REG}} \geq 4.5\text{ V}$	3.0	–	18	V
$I_{\text{I(EN)}}$	enable input current	$V_{\text{I(EN)}} = 5\text{ V}$	–	0.3	–	μA
Regulator output: pin REG						
V_{REG}	output voltage	$8\text{ V} \leq V_P \leq 22\text{ V}$; $I_{\text{REG}} = 0.5\text{ mA}$	4.8	5.0	5.2	V
		$8\text{ V} \leq V_P \leq 22\text{ V}$; $I_{\text{REG}} = 0.5\text{ mA}$; $T_{\text{amb}} \leq 125\text{ °C}$	4.75	5.0	5.25	V
		$0.5\text{ mA} \leq I_{\text{REG}} \leq 100\text{ mA}$	4.75	5.0	5.25	V
		$6\text{ V} \leq V_P \leq 45\text{ V}$; $I_{\text{REG}} = 0.5\text{ mA}$	4.75	5.0	5.25	V
$V_{\text{REG(drop)}}$	dropout voltage	$V_P = 4.5\text{ V}$; $T_{\text{amb}} \leq 85\text{ °C}$; $I_{\text{REG}} = 50\text{ mA}$	–	0.18	0.3	V
$V_{\text{REG(stab)}}$	long-term stability		–	20	–	mV/1000 h
$\Delta V_{\text{REG(line)}}$	line input regulation voltage	$8\text{ V} \leq V_P \leq 16\text{ V}$; $I_{\text{REG}} = 0.5\text{ mA}$	–	1	10	mV
		$7\text{ V} \leq V_P \leq 22\text{ V}$; $I_{\text{REG}} = 0.5\text{ mA}$	–	1	30	mV
		$7\text{ V} \leq V_P \leq 45\text{ V}$	–	1	50	mV
$\Delta V_{\text{REG(load)}}$	load output regulation voltage	$0.5\text{ mA} \leq I_{\text{REG}} \leq 50\text{ mA}$	–	10	50	mV
SVRR	supply voltage ripple rejection	$f_i = 120\text{ Hz}$; $V_{\text{i(ripple)}} = 1\text{ V (RMS)}$; $I_{\text{REG}} = 0.5\text{ mA}$	50	60	–	dB
$I_{\text{REG(ctrl)}}$	current limit	$V_{\text{REG}} > 4.5\text{ V}$	0.13	0.25	–	A
$I_{\text{LO(rp)}}$	output leakage current at reverse polarity	$V_P = -15\text{ V}$; $V_{\text{REG}} \leq 0.3\text{ V}$	–	1	500	μA

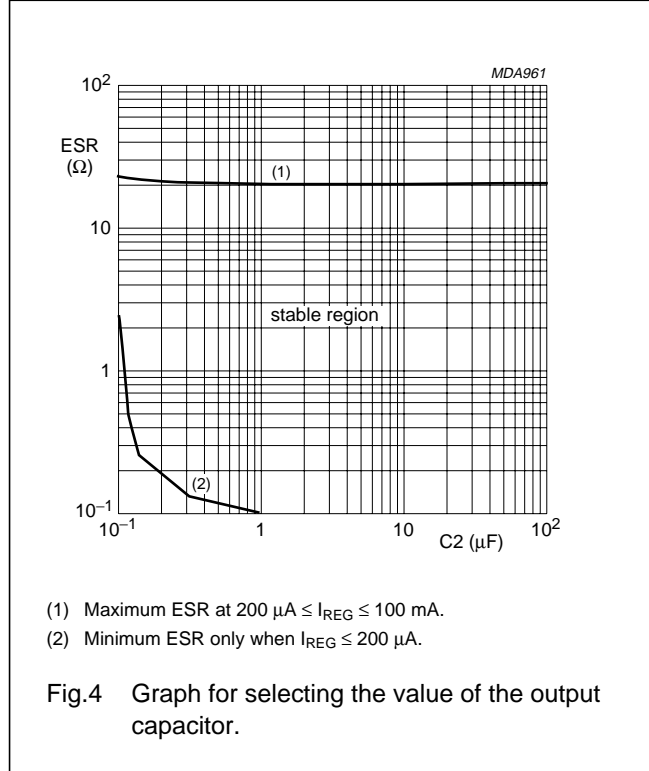
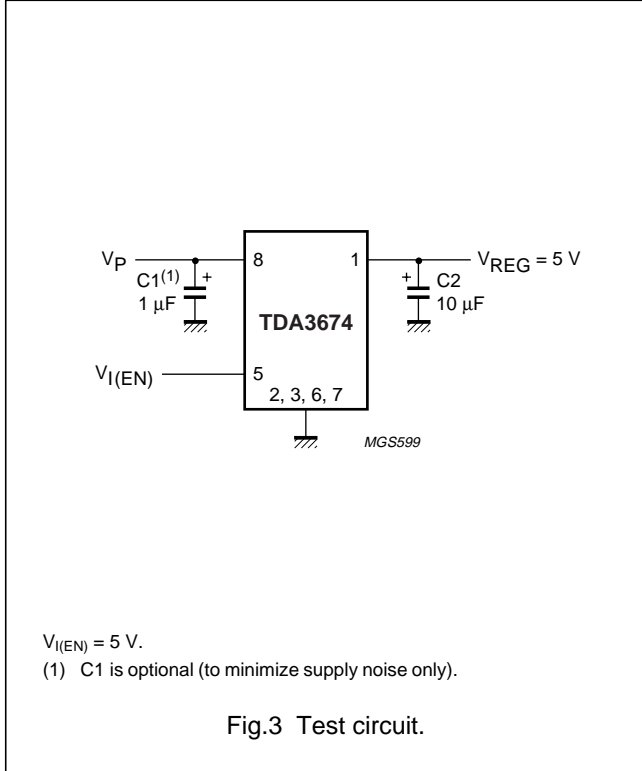
Note

1. The regulator output will follow V_P if $V_P < V_{\text{REG}} + V_{\text{REG(drop)}}$.

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TEST AND APPLICATION INFORMATION



Noise

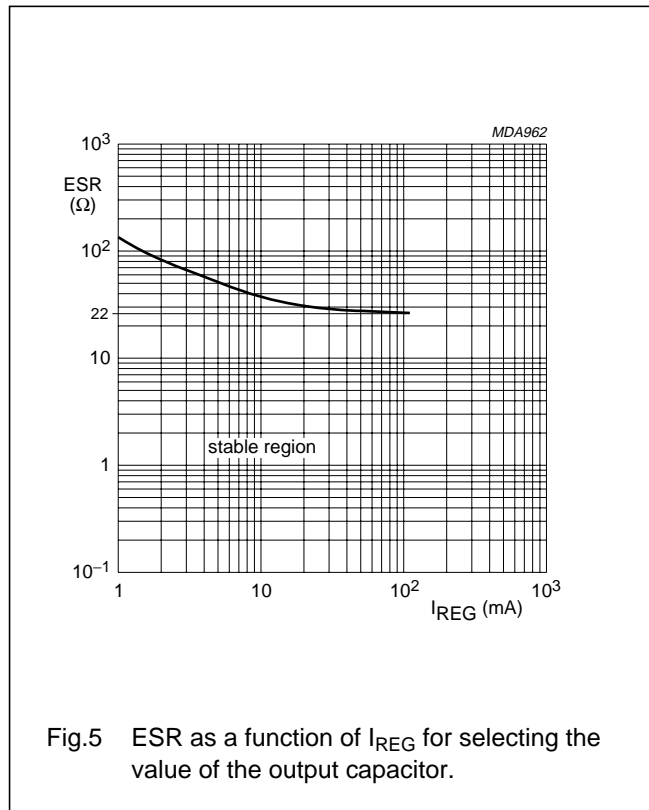
The output noise is determined by the value of the output capacitor. The noise figure is measured at a bandwidth of 10 Hz to 100 kHz (see Table 1).

Table 1 Noise figures

OUTPUT CURRENT I_{REG} (mA)	NOISE FIGURE (μV)		
	C2 = 10 μF	C2 = 47 μF	C2 = 100 μF
0.5	550	320	300
50	650	400	400

Stability

The regulator is stabilized with an external capacitor connected to the output. The value of this capacitor can be selected using the diagrams shown in Figs 4 and 5. The following four examples show the effects of the stabilization circuit using different values for the output capacitor.



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EXAMPLE 1

The regulator is stabilized with an electrolytic capacitor of 68 μF (ESR = 0.5 Ω). At T_{amb} = -40 °C, the capacitor value is decreased to 22 μF and the ESR is increased to 3.5 Ω. The regulator will remain stable at a temperature of T_{amb} = -40 °C.

EXAMPLE 2

The regulator is stabilized with an electrolytic capacitor of 10 μF (ESR = 3.3 Ω). At T_{amb} = -40 °C, the capacitor value is decreased to 3 μF and the ESR is increased to 20 Ω. The regulator will remain stable at a temperature of T_{amb} = -40 °C.

EXAMPLE 3

The regulator is stabilized with a 100 nF MKT capacitor connected to the output. Full stability is guaranteed when the output current is larger than 200 μA. Because the thermal influence on this capacitor value is almost zero, the regulator will remain stable at a temperature of T_{amb} = -40 °C.

EXAMPLE 4

The regulator is stabilized with a 100 nF capacitor in parallel with a electrolytic capacitor of 10 μF connected to the output.

The regulator is now stable under all conditions and independent of:

- The ESR of the electrolytic capacitor
- The value of the electrolytic capacitor
- The output current.

Application circuits

The maximum output current of the regulator equals:

$$I_{REG(max)} = \frac{150 - T_{amb}}{R_{th(j-a)} \times (V_P - V_{REG})}$$

$$= \frac{150 - T_{amb}}{100 \times (V_P - 5)} \text{ (mA)}$$

When T_{amb} = 21 °C and V_P = 14 V, the maximum output current equals 140 mA.

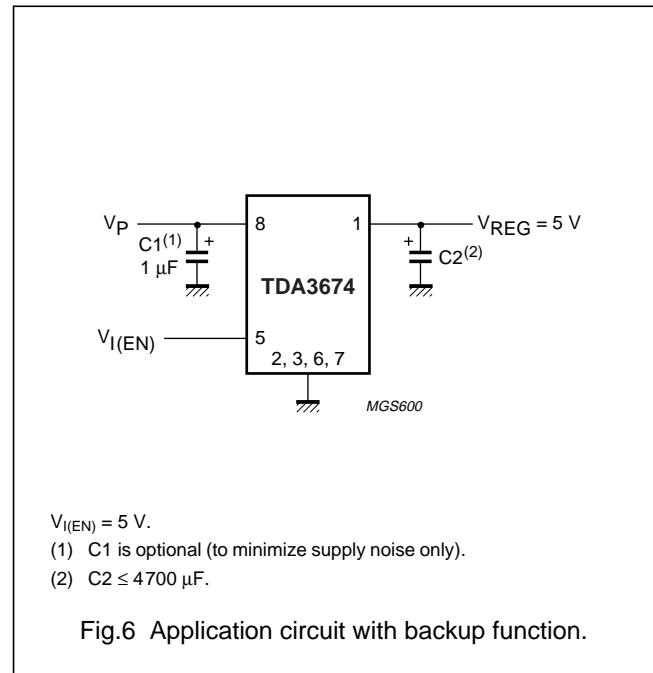
For successful operation of the IC (maximum output current capability) special attention has to be given to the copper area required as heatsink (connected to all GND pins), the thermal capacity of the heatsink and its ability to transfer heat to the external environment. It is possible to reduce the total thermal resistance from 120 to 50 K/W.

APPLICATION CIRCUIT WITH BACKUP FUNCTION

Sometimes a backup function is needed to supply, for example, a microcontroller for a short period of time when the supply voltage spikes to 0 V (or even -1 V).

This function can easily be built with the TDA3674 by using an output capacitor with a large value. When the supply voltage is 0 V (or -1 V), only a small current will flow into pin REG from this output capacitor (a few μA).

The application circuit is given in Fig.6.

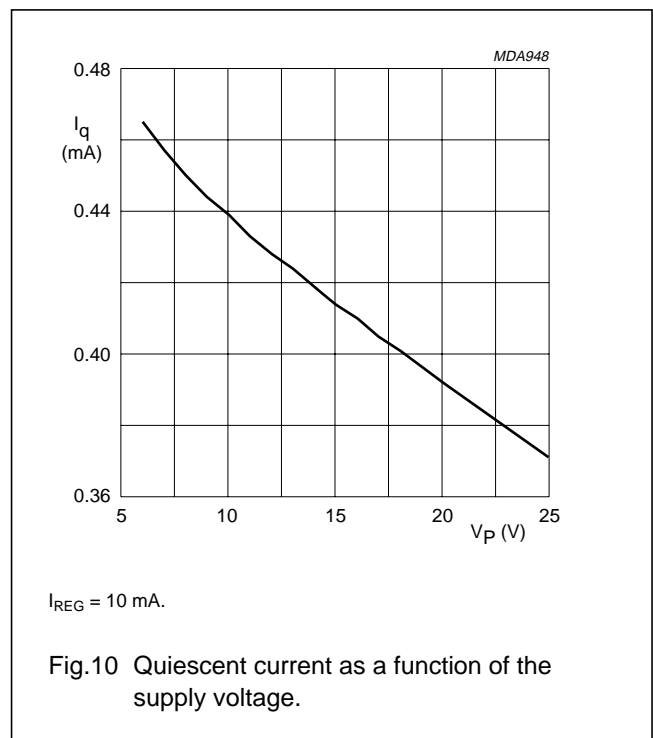
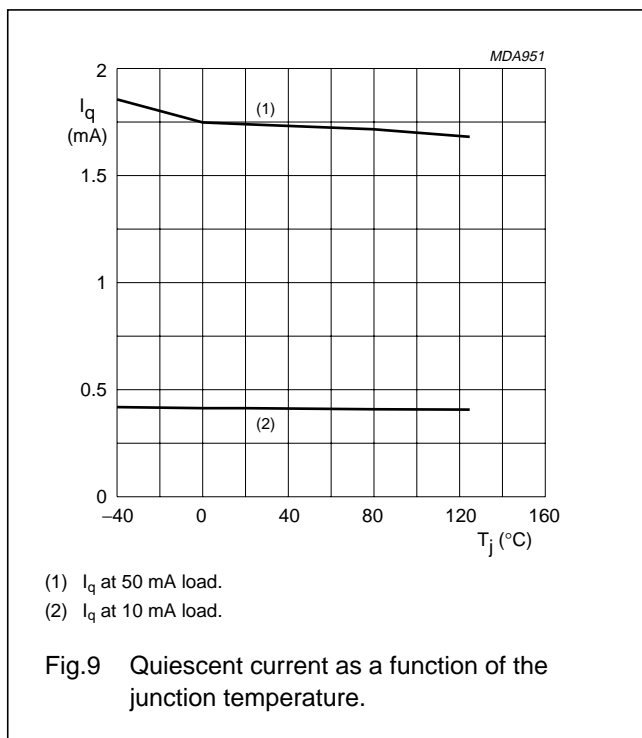
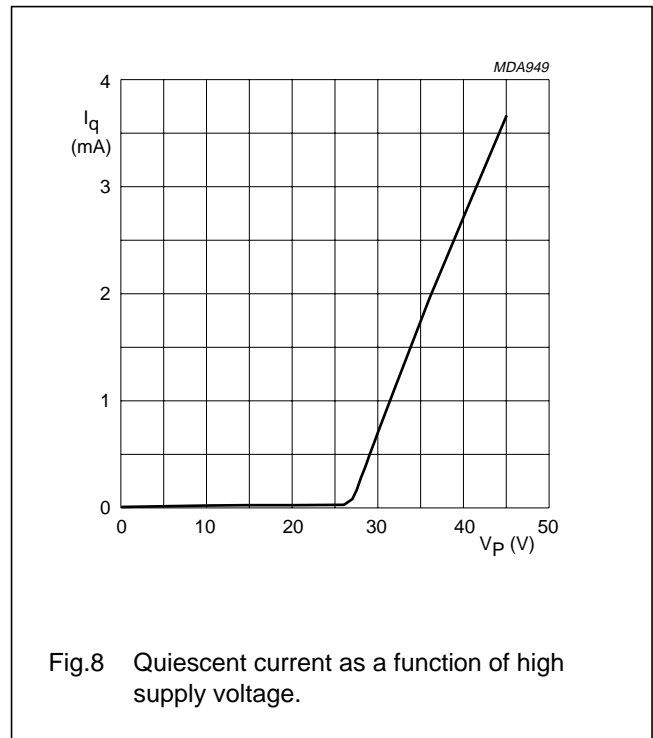
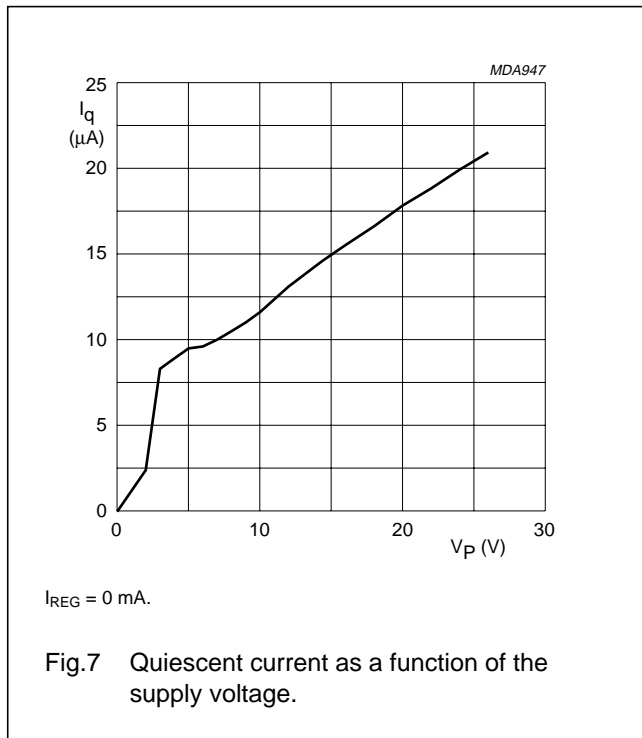


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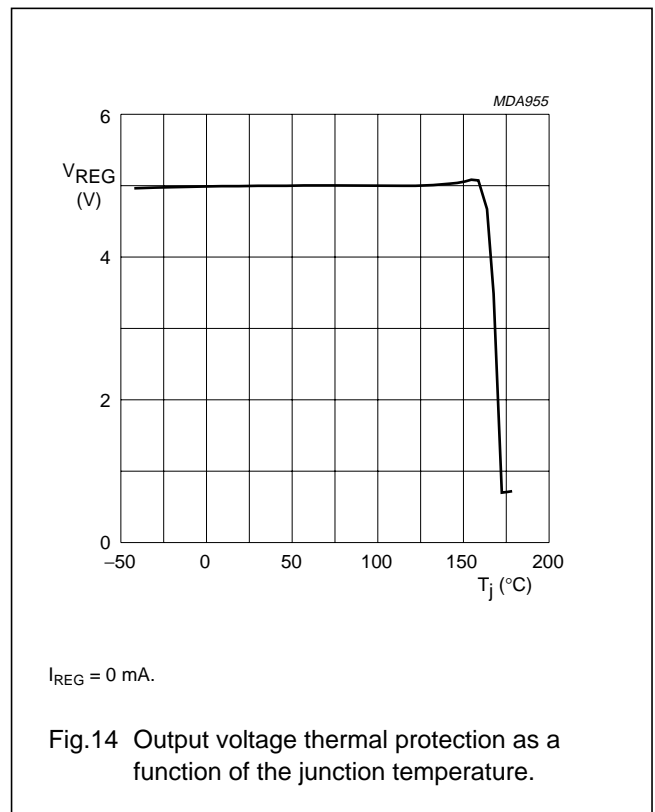
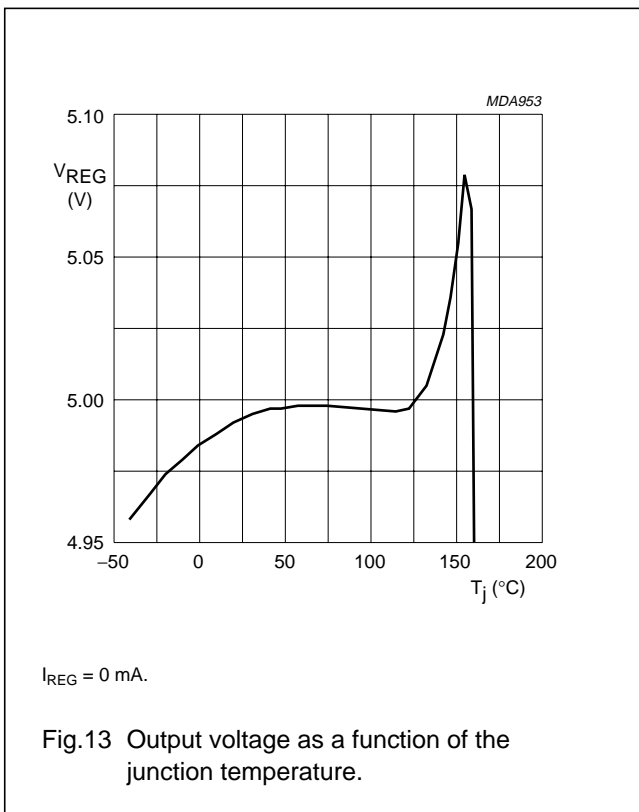
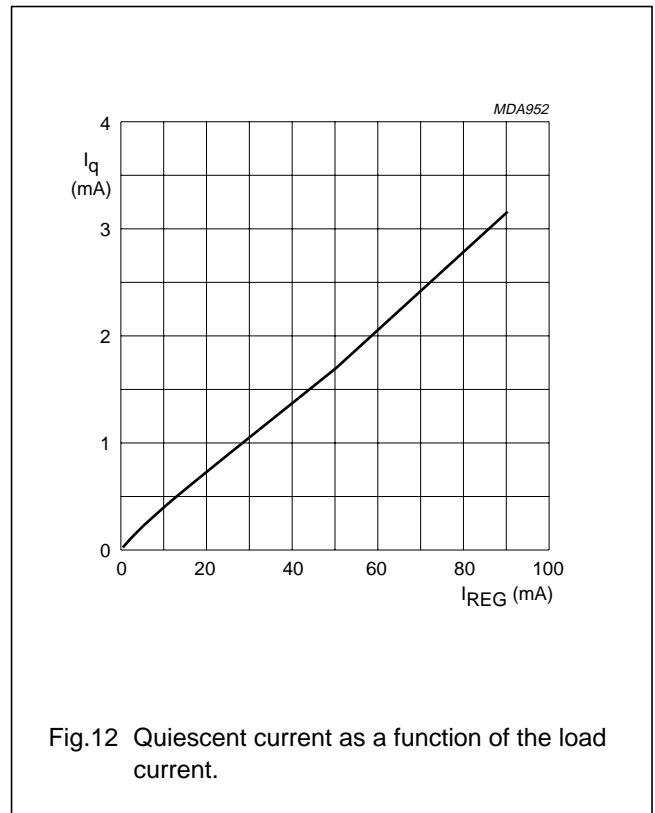
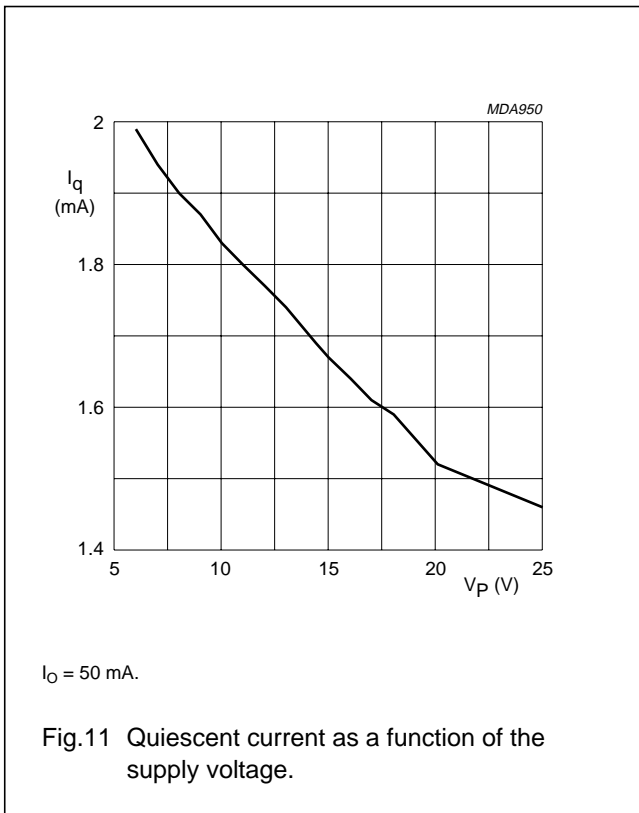
Additional application information

This section gives typical curves for various parameters measured on the TDA3674AT. Standard test conditions are: $V_P = 14.4\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$.



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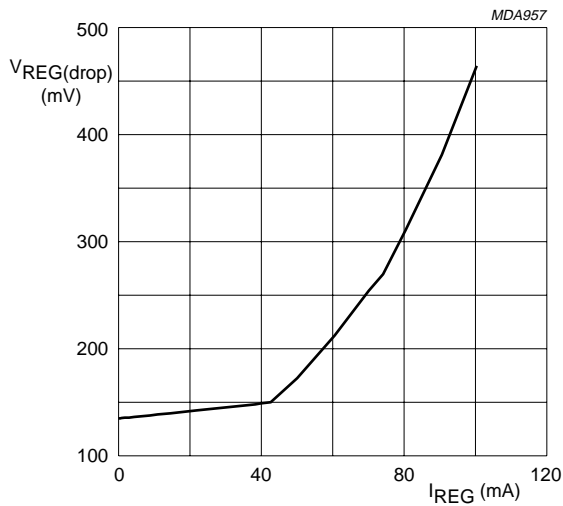
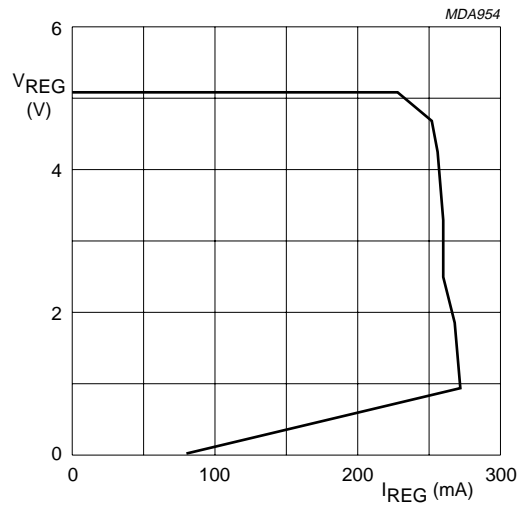
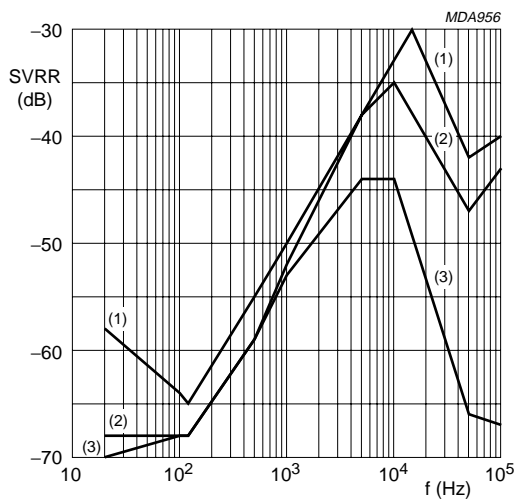


Fig.15 Dropout voltage as a function of the output current.



$V_P = 8\text{ V}$ with pulsed load.

Fig.16 Fold back protection mode.



$I_{REG} = 10\text{ mA}$; $C_2 = 10\text{ }\mu\text{F}$.

- (1) SVRR at $R_L = 100\text{ }\Omega$.
- (2) SVRR at $R_L = 500\text{ }\Omega$.
- (3) SVRR at $R_L = 10\text{ k}\Omega$.

Fig.17 SVRR as a function of the ripple frequency.

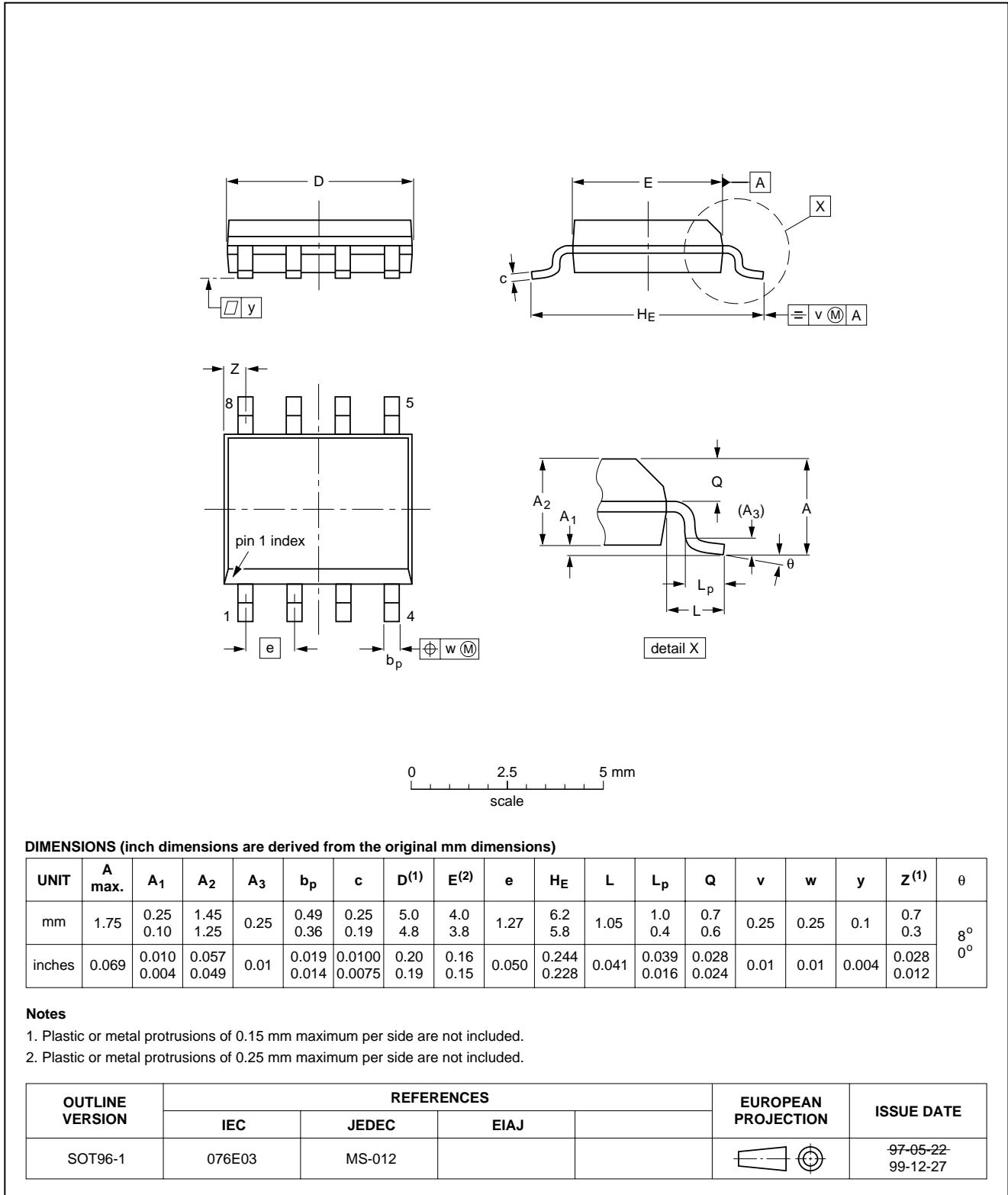
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PACKAGE OUTLINE

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



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SOLDERING

Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferably be kept below 220 °C for thick/large packages, and below 235 °C for small/thin packages.

Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is **preferred** to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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Suitability of surface mount IC packages for wave and reflow soldering methods

PACKAGE	SOLDERING METHOD	
	WAVE	REFLOW ⁽¹⁾
BGA, LFBGA, SQFP, TFBGA	not suitable	suitable
HBCC, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, SMS	not suitable ⁽²⁾	suitable
PLCC ⁽³⁾ , SO, SOJ	suitable	suitable
LQFP, QFP, TQFP	not recommended ⁽³⁾⁽⁴⁾	suitable
SSOP, TSSOP, VSO	not recommended ⁽⁵⁾	suitable

Notes

1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the “Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods”.
2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

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DATA SHEET STATUS

DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS ⁽¹⁾
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Note

1. Please consult the most recently issued data sheet before initiating or completing a design.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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